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Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

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CFP2 / CFP4

The CFP2 and CFP4 (surface mount receptacle connector) are considered as a candidate of future generation of multi hundred Gbps system. Both are 0.6mm pitch with the CFP2 having 104 positions and the CFP4 having 56 positions. They are rated for 28 Gbps per channel with resonance dampening for improved signal integrity. Both the CFP2 and CFP4 have a plug connector on the mating interface that improves accuracy and aids in achieving high speed performance.



Specification Highlights

The CFP2 and CFP4 interconnect systems are comprised of insert molding assemblies for top side contacts and press-fit cage assemblies.

Current Mechanical Characteristics

| | | CFP2 | CFP4 |
|------------------|---|---|------------------------------------|
| • | RSS Tolerance | 0.19mmMin | |
| • • • • | Host Depth (mm) Host Height (mm) Ports in 365(445)mm Faceplate Max Insertion Force with Heat-sink: Max Insertion Force without Heat-sink: Max Withdrawal Force without Heat-sink: Max Withdrawal Force without Heat-sink: | 84.5 12.9 8(10) 6N 4.5N 5.4N 3.9N | 67 10 16(19) 4.0N 2.5N |

Materials

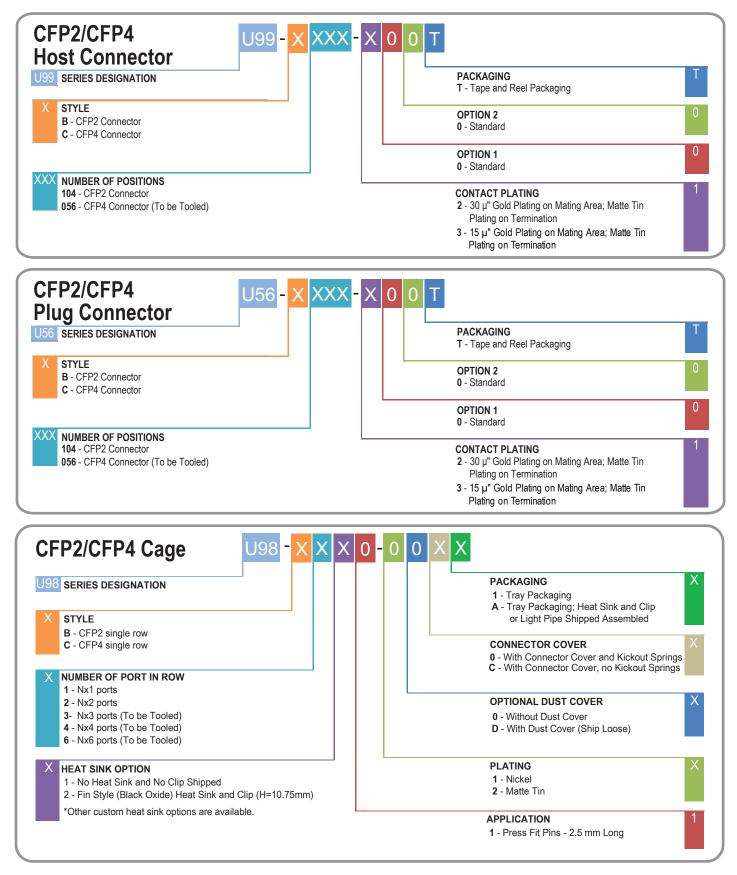
- Cage
 - o Base Material: Copper Alloy
 - o Heat Sink: Aluminum Alloy

Options

- Heat Sink
- Dust Cover
- Connector Cover
- EMI Gasket

Electrical Characteristics

Operating Voltage: 3.3 V



Website: www.amphenol-highspeed.com All specifications are subject to change without notice. Email: cages@amphenol-highspeed.com